

## PATENT ASSIGNMENT

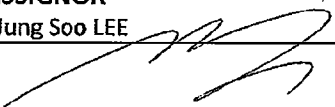
Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jung Soo LEE</td> <td>01/11/2013</td> </tr> <tr> <td>Satoshi NAKAMOTO</td> <td>01/11/2013</td> </tr> <tr> <td>Chie ISSHI</td> <td>01/11/2013</td> </tr> <tr> <td>Masaru NAKAMURA</td> <td>01/11/2013</td> </tr> </tbody> </table>		Name	Execution Date	Jung Soo LEE	01/11/2013	Satoshi NAKAMOTO	01/11/2013	Chie ISSHI	01/11/2013	Masaru NAKAMURA	01/11/2013
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<table border="1"> <tr> <td>Name:</td> <td>SANKEN ELECTRIC CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>3-6-3, Kitano, Niiza-shi</td> </tr> <tr> <td>City:</td> <td>Saitama</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>352-8666</td> </tr> </table>		Name:	SANKEN ELECTRIC CO., LTD.	Street Address:	3-6-3, Kitano, Niiza-shi	City:	Saitama	State/Country:	JAPAN	Postal Code:	352-8666
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CORRESPONDENCE DATA											
<p>Fax Number: 2028243001</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 202-824-3000</p> <p>Email: rblackwell@bannerwitcoff.com, BWPTOPAT@bannerwitcoff.com</p> <p>Correspondent Name: BANNER &amp; WITCOFF, LTD.</p> <p>Address Line 1: 1100 13th STREET, N.W.</p> <p>Address Line 2: SUITE 1200</p> <p>Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20005-4051</p>											
ATTORNEY DOCKET NUMBER:	036777.00014										
NAME OF SUBMITTER:	Chunhsi Andy Mu										
This document serves as an Oath/Declaration (37 CFR 1.63).											
<p>Total Attachments: 2</p> <p>source=Assignment#page1.tif</p> <p>source=Assignment#page2.tif</p>											

CH \$40.00 13744798

**COMBINED DECLARATION AND ASSIGNMENT**

<b>TITLE OF INVENTION:</b>	SWITCHING POWER-SUPPLY DEVICE AND METHOD FOR MANUFACTURING SWITCHING POWER-SUPPLY DEVICE
<b>DECLARATION</b>	
<p>As a below named inventor, I hereby declare that:</p> <ul style="list-style-type: none"> <li>This declaration is directed to: <ul style="list-style-type: none"> <li><input checked="" type="checkbox"/> The attached application, or</li> <li><input type="checkbox"/> United States application or PCT International application number _____ filed on _____.</li> </ul> </li> <li>I believe that I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.</li> <li>The above-identified application was made or authorized to be made by me.</li> </ul> <p>I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.</p>	
<b>ASSIGNMENT</b>	
<p><b>WHEREAS</b>, I, a below named Inventor/Assignor, have invented the above invention, having the following application number and filing date:</p> <p style="text-align: center;">U.S. Application No. <u>13/744,798</u>, filed <u>January 18, 2013</u>.</p> <p>If the above lines are blank, I hereby authorize the attorneys for Assignee to insert the filing date and application number immediately above after they become known and prior to recording this document.</p> <p><b>WHEREAS</b>, <u>SANKEN ELECTRIC CO., LTD.</u>, a corporation duly organized under the laws of <u>Japan</u>, and having its offices and a place of business at <u>3-6-3, Kitano, Niiza-shi, Saitama, 352-8666 Japan</u> ("Assignee"), is desirous of acquiring the entire right, title and interest in and to the aforesaid inventions and in and to all applications and Letters Patent therefor granted in the United States of America, and in any and all countries foreign thereto:</p> <p><b>NOW, THEREFORE, TO WHOM IT MAY CONCERN</b>, be it known that, for good and valuable consideration, including salary and/or payment for the making of inventions, or employee benefits, the receipt and sufficiency of which are hereby acknowledged, I said Assignor, by these presents do sell, assign and transfer unto said Assignee, its successors, assigns and legal representatives, the full and exclusive right, title and interest for the territory of the United States of America and all countries foreign thereto, and throughout the world and in space, (including the right to apply for Letters Patent in foreign countries in its own name and to claim any priority rights for such foreign applications to which such applications are entitled under international conventions, treaties, or otherwise), in and to said inventions and in and to all applications and Letters Patent granted therefor, and all non-provisionals, divisionals, reissues, reexaminations, continuations, continuation-in-parts and extensions thereof, and in and to all copyrights, trademarks with their associated goodwill, trade secrets, confidential information, and compilations, necessary or useful to make, use, or sell the inventions.</p> <p>I hereby authorize and request the Commissioner of Patents, and any official whose duty it is to issue patents, to issue all Letters Patent on said inventions or resulting therefrom to said Assignee, or its successors and assigns, as assignee of the entire right, title and interest. I represent and warrant that I have full right to agree to, execute, and deliver this assignment.</p> <p>I agree that I will without further consideration, but at the expense of Assignee, communicate to said Assignee, or its successors, assigns, or nominees, any and all facts known to me regarding said inventions whenever requested, and that I will execute all non-provisional, divisional, reissue, reexamination, continuation and continuation-in-part applications, testify in any legal proceedings, sign all lawful papers, make all rightful oaths, and generally do everything reasonable for said Assignee, its successors, assigns, and nominees, to obtain and enforce proper patent protection for said inventions in all countries.</p>	
<b>INVENTOR/ASSIGNOR</b>	
Legal Name: Jung Soo LEE	
Signature: 	
Date: 2013. 1. 11 (Jan. 11. 2013)	

<b>INVENTOR/ASSIGNOR</b> Legal Name: Satoshi NAKAMOTO
Signature: <i>Satoshi Nakamoto</i>
Date: <i>Jan. 11, 2013</i>
<b>INVENTOR/ASSIGNOR</b> Legal Name: Chie ISSHI
Signature: <i>Chie Isshi</i>
Date: <i>Jan. 11, 2013</i>
<b>INVENTOR/ASSIGNOR</b> Legal Name: Masaru NAKAMURA
Signature: <i>Masaru Nakamura</i>
Date: <i>Jan. 11, 2013</i>
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